

# A O 4438 60V N-Channel MOSFET

### **General Description**

The AO4438 uses advanced trench technology to provide excellent  $R_{\text{DS(ON)}}$  and low gate charge. This device is suitable for use as a load switch or in PWM applications.

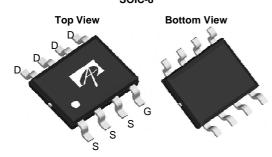
## **Product Summary**

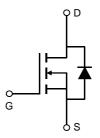
$$\begin{split} &V_{DS} \; (V) = 60V \\ &I_{D} = 8.2A \; (V_{GS} = 10V) \\ &R_{DS(ON)} < 22m\Omega \; (V_{GS} = 10V) \\ &R_{DS(ON)} < 27m\Omega \; (V_{GS} = 4.5V) \end{split}$$

100% UIS Tested 100% Rg Tested









Absolute maximum ratings T <sub>A</sub> =200 amess otherwise noted							
Parameter		Symbol	Maximum	Units			
Drain-Source Voltage		V <sub>DS</sub>	60	V			
Gate-Source Voltage		$V_{GS}$	±20	V			
Continuous Drain	T <sub>A</sub> =25℃		8.2				
Current <sup>A</sup>	T <sub>A</sub> =70℃	I <sub>D</sub>	6.6	А			
Pulsed Drain Current <sup>B</sup>		I <sub>DM</sub>	40				
	T <sub>A</sub> =25℃	P <sub>D</sub>	3.1	W			
Power Dissipation	T <sub>A</sub> =70℃		2	- vv			
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	${\mathfrak C}$			

Thermal Characteristics								
Parameter		Symbol Typ Max		Max	Units			
Maximum Junction-to-Ambient A	t ≤ 10s	В	24	40	°C/W			
Maximum Junction-to-Ambient A	Steady-State	$R_{\theta JA}$	54	75	C/W			
Maximum Junction-to-Lead <sup>C</sup>	Steady-State	$R_{ heta JL}$	21	30	℃/W			



#### N Channel Electrical Characteristics (T<sub>J</sub>=25℃ unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units		
STATIC PARAMETERS									
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V		60			V		
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS}$ =60V, $V_{GS}$ =0V				1	μΑ		
			T <sub>J</sub> =55℃			5	μΑ		
$I_{GSS}$	Gate-Body leakage current	$V_{DS}$ =0V, $V_{GS}$ = ±20V				100	nA		
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=250\mu A$		2	2.3	3	V		
	Static Drain-Source On-Resistance	$V_{GS}$ =10V, $I_D$ =8.2A			16.3	22	mΩ		
R <sub>DS(ON)</sub>			T <sub>J</sub> =125℃		30	40			
		$V_{GS}$ =4.5V, $I_{D}$ =7.6A			20	27	mΩ		
g <sub>FS</sub>	Forward Transconductance	$V_{DS}$ =5V, $I_{D}$ =8.2A		24		S			
$V_{SD}$	Diode Forward Voltage	I <sub>S</sub> =1A,V <sub>GS</sub> =0V			0.74	1	V		
Is	Maximum Body-Diode Continuous Current					3	Α		
DYNAMIC	PARAMETERS								
C <sub>iss</sub>	Input Capacitance			1920	2300	pF			
C <sub>oss</sub>	Output Capacitance	$V_{GS}$ =0V, $V_{DS}$ =30V, f=1MHz			155		pF		
$C_{rss}$	Reverse Transfer Capacitance			116		pF			
$R_g$	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz			0.65	0.8	Ω		
SWITCHI	NG PARAMETERS								
Q <sub>g</sub> (10V)	Total Gate Charge	-V <sub>GS</sub> =10V, V <sub>DS</sub> =30V, I <sub>D</sub> =8.2A			47.6	58	nC		
Q <sub>g</sub> (4.5V)	Total Gate Charge				24.2	30	nC		
$Q_{gs}$	Gate Source Charge				6		nC		
$Q_{gd}$	Gate Drain Charge				14.4		nC		
t <sub>D(on)</sub>	Turn-On DelayTime				8.2		ns		
t <sub>r</sub>	Turn-On Rise Time	$V_{GS}$ =10V, $V_{DS}$ =30V, $R_L$ =3.6 $\Omega$ , $R_{GEN}$ =3 $\Omega$			5.5		ns		
$t_{D(off)}$	Turn-Off DelayTime				29.7		ns		
t <sub>f</sub>	Turn-Off Fall Time				5.2		ns		
t <sub>rr</sub>	Body Diode Reverse Recovery Time	$I_F$ =8.2A, dI/dt=100A/ $\mu$	s		34	41	ns		
$Q_{rr}$	Body Diode Reverse Recovery Charge	I <sub>F</sub> =8.2A, dI/dt=100A/μs			53		nC		

A: The value of R <sub>BJA</sub> is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T <sub>A</sub>=25° C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating. B: Repetitive rating, pulse width limited by junction temperature.

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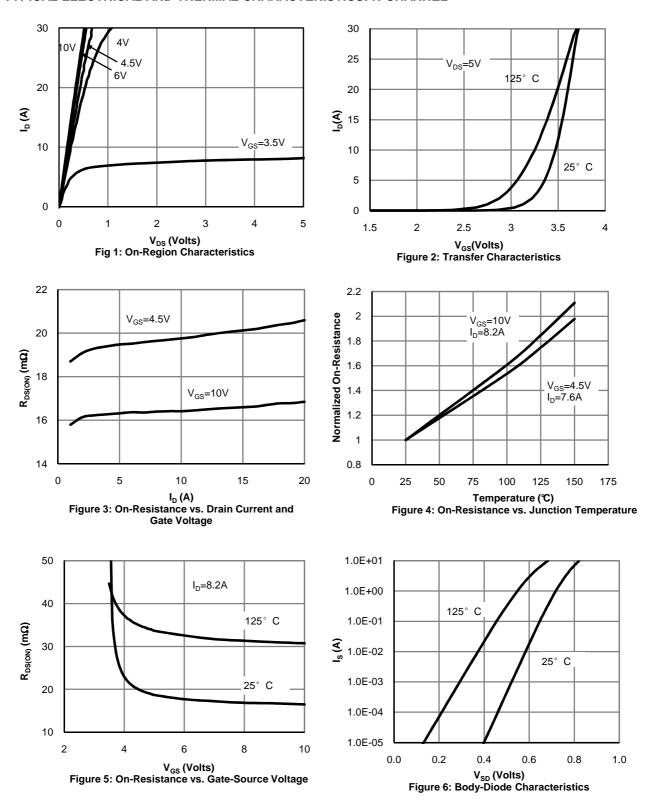
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C. The R  $_{\theta JA}$  is the sum of the thermal impedence from junction to lead R  $_{\theta JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using <300  $\mu$ s pulses, duty cycle 0.5% max. E. These tests are performed with the device mounted on 1 in  $^2$  FR-4 board with 2oz. Copper, in a still air environment with T  $_A$ =25 $^\circ$  C. The SOA curve provides a single pulse rating.

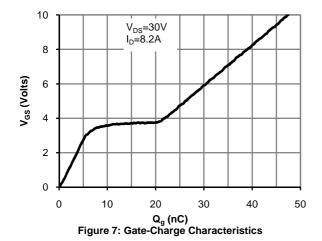


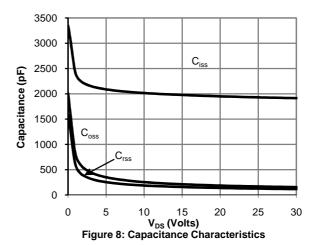
#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS: N-CHANNEL

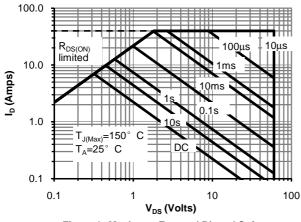




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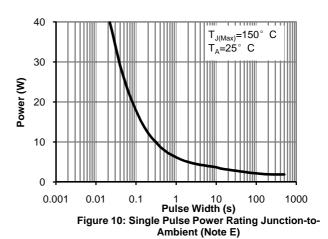


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

